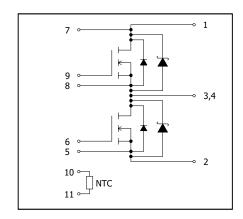
Application

- · Motor drive
- · Inverter, Converter
- · Photovoltaics, wind power generation.
- · Induction heating equipment.

Features

- 1) Low surge, low switching loss.
- 2) High-speed switching possible.
- 3) Reduced temperature dependence.

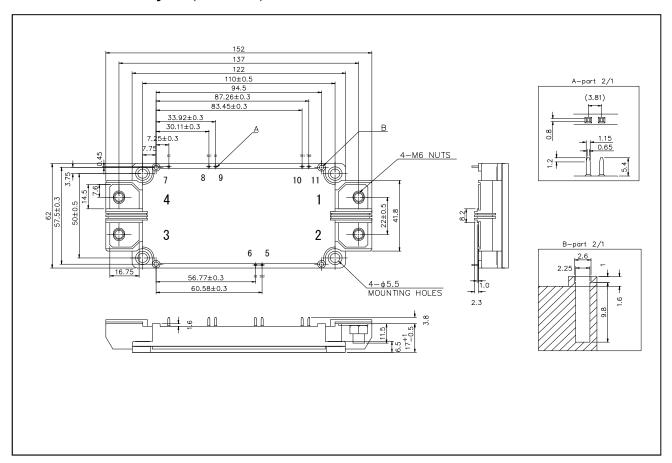
●Circuit diagram



Construction

This product is a half bridge module consisting of SiC-UMOSFET and SiC-SBD from ROHM.

● Dimensions & Pin layout (Unit : mm)

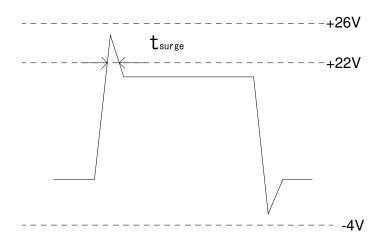


●Absolute maximum ratings (T_j = 25°C)

Parameter	Symbol	Conditions	Limit	Unit		
Drain-source voltage	V _{DSS} G-S short		1200			
Gate-source voltage(+)	V		22	V		
Gate-source voltage(-)	V_{GSS}	D-S short	-4	V		
G - S Voltage (t _{surge} <300nsec)	$V_{GSSsurge}$		-4 to 26			
Drain current *1	I _D	DC (T _c =60°C) V _{GS} =18V	358			
	I _D	DC (T _c =32°C) V _{GS} =18V	400			
	I _{DRM}	Pulse (T_c =60°C) 1ms V_{GS} =18V *2	800			
Source current *1	I _S	DC (T _c =60°C) V _{GS} =18V	358	Α		
	I _S	DC (T _c =32°C) V _{GS} =18V	400	A		
	I _S	DC (T _c =60°C) V _{GS} =0V	260			
	I _{SRM}	Pulse (Tc=60°C) 1ms V _{GS} =18V * ²	800			
	I _{SRM}	Pulse (Tc=60°C) 10μs V _{GS} =0V * ²	800			
Total power disspation *3	Ptot	T _c =25°C	1570	W		
Max Junction Temperature	T _{jmax}		175			
Junction temperature	T _{jop}		-40 to150	°C		
Storage temperature	T _{stg}		-40 to125			
Isolation voltage	Visol	Terminals to baseplate, f=60Hz AC 1min. 2500		Vrms		
Mounting torque	-	Main Terminals : M6 screw	4.5	N · m		
		Mounting to heat shink: M5 screw	3.5			

^(*1) Case temperature (T_c) is defined on the surface of base plate just under the chips.

■Example of acceptable V_{GS} waveform



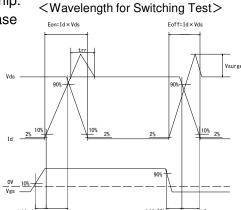
^(*2) Repetition rate should be kept within the range where temperature rise if die should not exceed T_{i max.}

^(*3) T_j is less than 175°C

●Electrical characteristics (T_i=25°C)

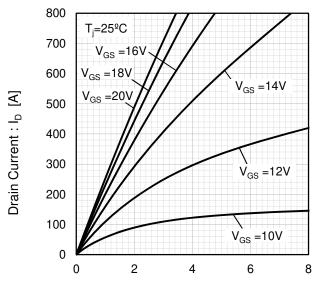
Symbol	Conditions		Min.	Тур.	Max.	Unit
V _{DS(on)}	I _D =400A, V _{GS} =18V	T _j =25°C	-	1.8	2.5	V
		T _j =125°C	-	2.6	-	
		T _j =150°C	-	3.0	4.5	
I _{DSS}	$V_{DS} = 1200V, V_{GS} = 0V$	-	-	2.4	mA	
V_{SD}	V _{GS} =0V, I _S =400A	T _j =25°C	ı	2.1	2.6	V
		T _j =125°C	ı	2.7	-	
		T _j =150°C	-	2.8	4.8	
	V _{GS} =18V, I _S =400A	T _j =25°C	-	1.3	-	V
		T _j =125°C	-	1.8	-	
		T _j =150°C	-	1.9	-	
$V_{GS(th)}$	$V_{DS}=10V, I_{D}=109.2mA$	V _{DS} =10V, I _D =109.2mA			5.6	V
I _{GSS}	V _{GS} =22V, V _{DS} =0V			-	0.5	μА
	$V_{GS} = -4V, V_{DS} = 0V$		-0.5	ı	-	
t _{d(on)}	$V_{GS(on)} = 18V, V_{GS(off)} = -2V^{*4}$		ı	45	-	ns
t _r	V _{DS} =600V	ı	55	-		
t _{rr}	I _D =400A	ı	45	-		
$t_{d(off)}$	$R_{G(on)}$ =2.2 Ω , $R_{G(off)}$ =2.2 Ω inductive load		1	240	-	
t _f			-	55	-	
Ciss	$V_{DS} = 10V, V_{GS} = 0V,200$	ı	17	-	nF	
R_{Gint}	T _j =25°C	1	2.4	-	Ω	
R25			ı	5.0	-	kΩ
B _{50/25}		1	3370	-	K	
Ls			•	10.5	-	nΗ
-	Terminal to heat sink		ı	16.7	-	mm
	Terminal to terminal		ı	16.7	-	mm
-	Terminal to heat sink		ı	12.0	-	mm
	Terminal to terminal		ı	11.0	ı	mm
R _{th} (j-c)	UMOS (1/2 module) *5		-	-	96	°C/kW
	SBD (1/2 module) *5		1	-	127	
R _{th} (c-f)	Case to heat sink, per		15			
	Thermal grease applie	ed * ⁶		10		
	$\begin{array}{c} V_{DS(on)} \\ \\ V_{DS(on)} \\ \\ \\ V_{SD} \\ \\ \\ \\ V_{SD} \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\$	$V_{DS(on)} \begin{tabular}{l}{l_{DSS}} & V_{DS} = 1200 V, V_{GS} = 0 V \\ \hline V_{QS} = 0 V, I_{S} = 400 A \\ \hline V_{SD} & V_{GS} = 18 V, I_{S} = 400 A \\ \hline V_{GS(th)} & V_{DS} = 10 V, I_{D} = 109.2 mA \\ \hline V_{GS} = 22 V, V_{DS} = 0 V \\ \hline V_{QS} = -4 V, V_{DS} = 0 V \\ \hline V_{DS} = 600 V \\ \hline V_{DS} = 600 V \\ \hline V_{DS} = 600 V \\ \hline V_{DS} = 10 V, V_{DS} = 0 V \\ \hline V_{DS} = 600 V \\ \hline V_{DS} = 600 V \\ \hline V_{DS} = 10 V, V_{DS} = 0 V, 200 \\ \hline V_{DS} = 10 V, V_{QS} = 0 V, 200 \\ \hline V_{DS} = 10 V, V_{DS} = 10 $	$V_{DS(on)} = V_{DS(on)} = V_{$	$V_{DS(on)} \begin{tabular}{ll} $I_{D}\!\!=\!\!400A, V_{GS}\!\!=\!\!18V$ & $T_{j}\!\!=\!\!125^{\circ}C$ & - \\ $T_{j}\!\!=\!\!150^{\circ}C$ & - \\ $T_{j}\!\!=\!\!150^{\circ}C$ & - \\ $V_{DS}\!\!=\!\!1200V, V_{GS}\!\!=\!\!0V$ & - \\ $V_{GS}\!\!=\!\!0V, I_{S}\!\!=\!\!400A$ & $T_{j}\!\!=\!\!125^{\circ}C$ & - \\ $T_{j}\!\!=\!\!150^{\circ}C$ & - \\ $T_{j}\!\!=\!\!150$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c} V_{DS(on)} \\ V_{DS(on)} \\ V_{DS(on)} \\ V_{DS(on)} \\ V_{DS} $

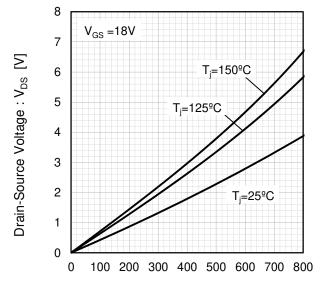
- (*4) In order to prevent self turn-on, it is recommended to apply negative gate bias.
- (*5) Measurement of Tc is to be done at the point just under the chip.
- (*6) Typical value is measured by using thermally conductive grease of $\lambda=0.9W/(m\cdot K)$.
- (*7) SiC devices have lower short cuicuit withstand capability due to high current density. Please be advised to pay careful attention to short cuicuit accident and try to adjust protection time to shutdown them as short as possible.
- (*8) If the Product is used beyond absolute maximum ratings defined in the Specifications, as its internal structure may be dameged, please replace such Product with a new one.



3/10

Fig.1 Typical Output Characteristics [$T_j=25^{\circ}C$] Fig.2 Drain-Source Voltage vs. Drain Current





Drain-Source Voltage: V_{DS} [V]

Drain Current : I_D [A]

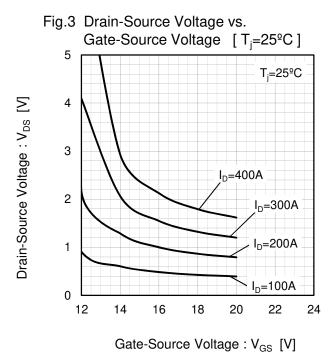
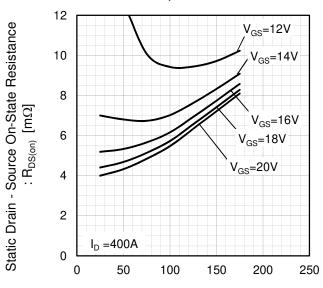
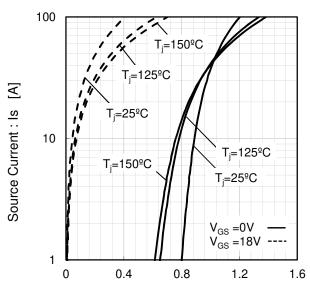


Fig.4 Static Drain - Source On-State Resistance vs. Junction Temperature



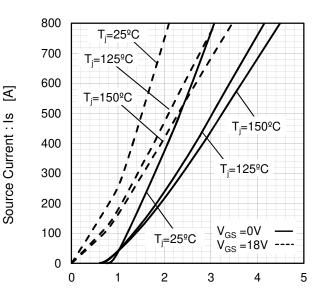
Junction Temperature : T_i [ºC]

Fig.5 Forward characteristic of Diode



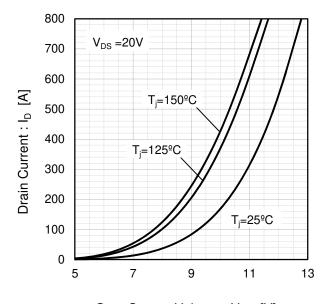
Source-Drain Voltage: V_{SD} [V]

Fig.6 Forward characteristic of Diode



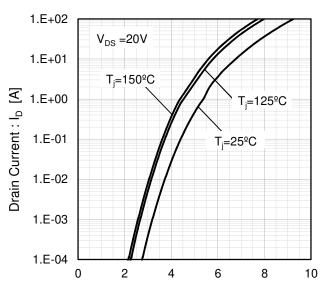
Source-Drain Voltage: V_{SD} [V]

Fig.7 Drain Current vs. Gate-Source Voltage



Gate-Source Voltage : V_{GS} [V]

Fig.8 Drain Current vs. Gate-Source Voltage



Gate-Source Voltage : V_{GS} [V]

Fig.9 Switching Characteristics [T_i=25°C]

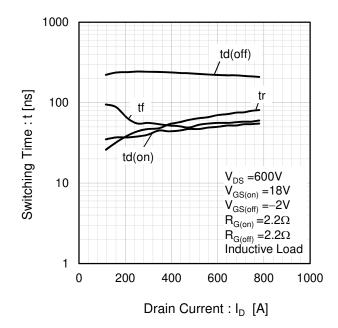


Fig.10 Switching Characteristics [T_i=125°C]

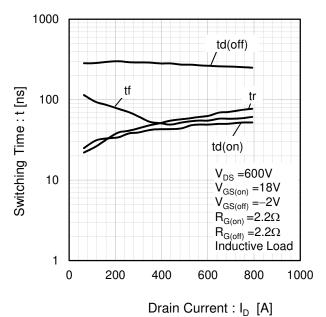


Fig.11 Switching Characteristics [T_i=150°C]

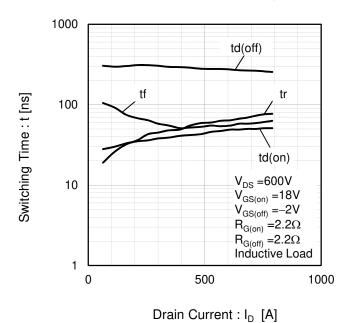
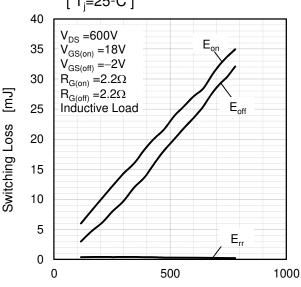
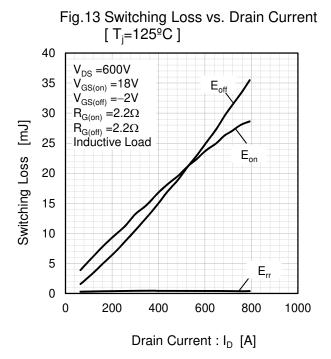
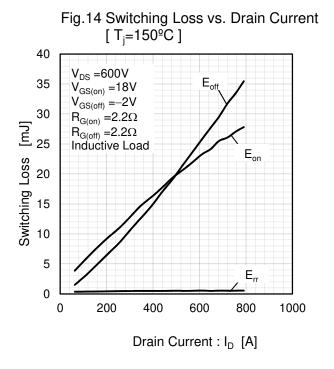
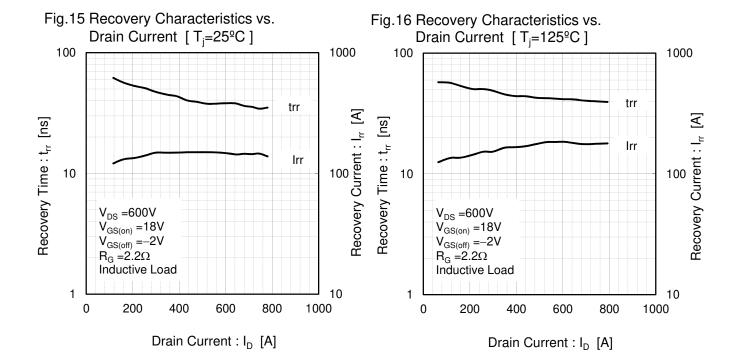


Fig.12 Switching Loss vs. Drain Current [$T_i=25^{\circ}C$]









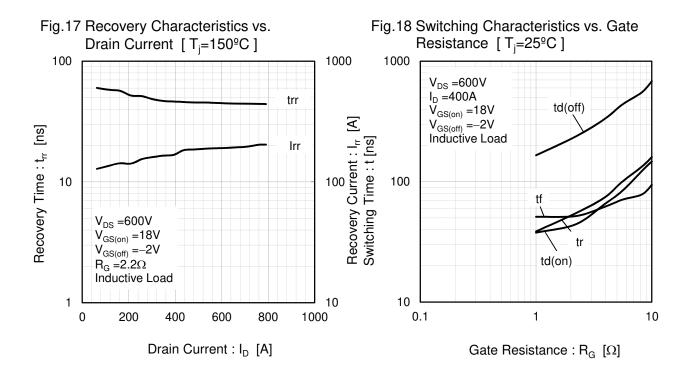


Fig.19 Switching Characteristics vs. Gate Resistance [$T_i=125^{\circ}C$]

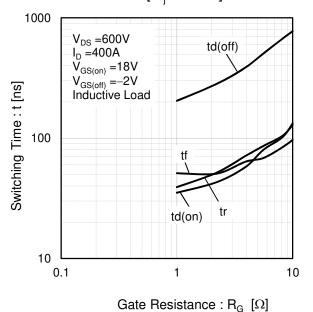
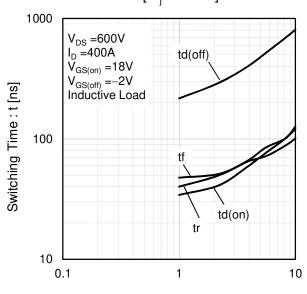


Fig.20 Switching Characteristics vs. Gate Resistance [$T_i=150^{\circ}C$]



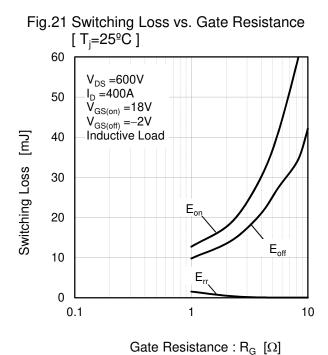


Fig.22 Switching Loss vs. Gate Resistance [T_j =125 $^{\circ}$ C]

60 V_{DS} =600V V_{DS} =400A $V_{GS(on)}$ =18V $V_{GS(off)}$ =-2VInductive Load

20

10

0.1

1 10

Gate Resistance : R_G [Ω]

Switching Loss [mJ]

Fig.23 Switching Loss vs. Gate Resistance $[T_i=150^{\circ}C]$ 50 V_{DS} =600V $I_{D} = 400A$ 40 $V_{GS(on)} = 18V$ V_{GS(off)} =-2V Inductive Load Switching Loss [mJ] 30 E 20 10 $\mathsf{E}_{\mathsf{off}}$ 0 0.1 1 10 Gate Resistance : R_G [Ω]

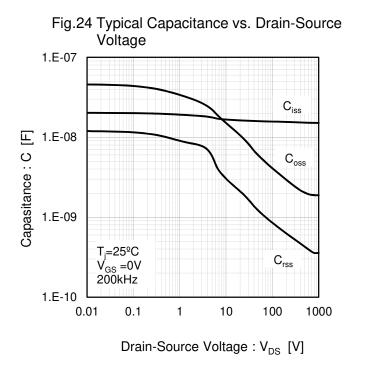


Fig.25 Gate Charge Characteristics

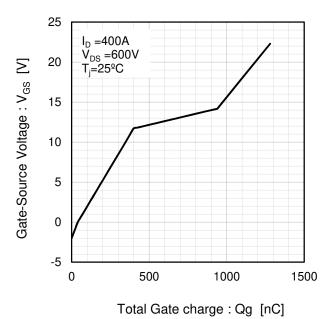


Fig.26 Normalized Transient Thermal Impedance 1 Normalized Transient Thermal Impedance: Zth 0.1 Single Pulse T_c=25^oC Per unit base DMOS part: 96°C/kW SBD part : 127ºC/kW 0.01 0.0001 0.001 0.1 10 0.01 1

Time [s]

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